

Click here for the 3D model.

Packaging Specifications

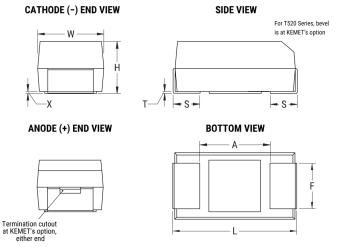
Packaging Packaging Quantity

T520W337M2R5ATE015

General Information

Specifications

T520, Tantalum, Polymer Tantalum, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 15 mOhms, 7343, Height Max = $\frac{1}{2}$



Series	T520
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low Profile/ESR, NonCombustible
Features	Low ESR
RoHS	Yes
Termination	Tin
AEC-Q200	No
Component Weight	222.95 mg
Shelf Life	52 Weeks
MSL	3

Dimensions	,
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	1.4mm +/-0.1mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
Α	3.6mm MIN
	0.0F DEE

Dimensions	,
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	1.4mm +/-0.1mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
Α	3.6mm MIN
X	0.05mm REF

	Capacitance	330 uF
	Capacitance Tolerance	20%
3		3 E V/DC (10EC)
nm +/-0.3mm	Voltage DC	2.5 VDC (105C)
nm +/-0.3mm	Temperature Range	-55/+105°C
m +/-0.1mm	Rated	
mm REF	Temperature	105°C
m +/-0.3mm	Life	2000 Hrs (105C)
nm +/-0.1mm	Humidity	60C, 90% RH, 500 Hours, No Load
nm MIN	Dissipation Factor	10% 120Hz 25C
5mm REF	Failure Rate	N/A
	Resistance	15 mOhms (100kHz 25C)
	Ripple Current	3500 mA (rms, 100kHz 45C), 2450 mA (rms, 85C), 875 mA (rms, 105C)
T&R, 178mm	Leakage Current	82.5 uA (5min 25°C)
1000		

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclain	n – any
warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the	
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obligation or liability for the advice given or results obtained.	

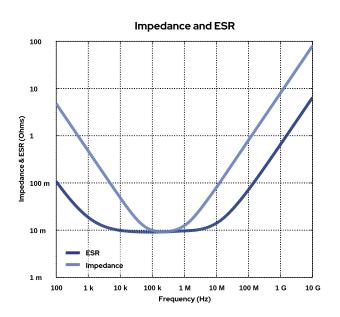


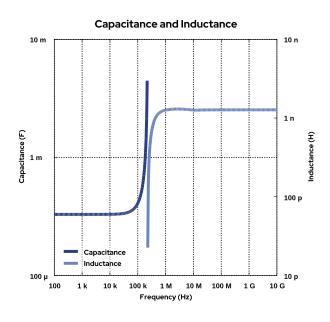
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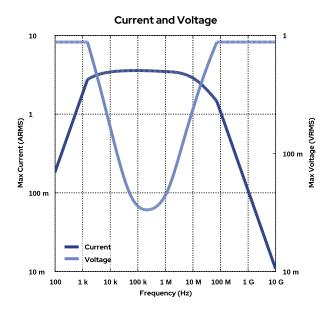
T520, Tantalum, Polymer Tantalum, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 15 mOhms, 7343, Height Max = 15 mm

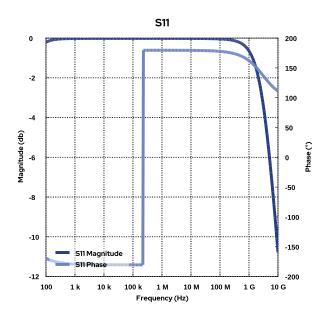
Simulations

For the complete simulation environment please visit K-SIM.





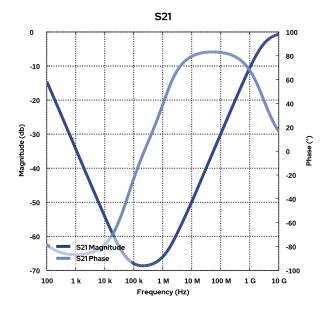






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T520, Tantalum, Polymer Tantalum, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 15 mOhms, 7343, Height Max = 1.5mm





T520W337M2R5ATE015

T520, Tantalum, Polymer Tantalum, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 15 mOhms, 7343, Height Max =

These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

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